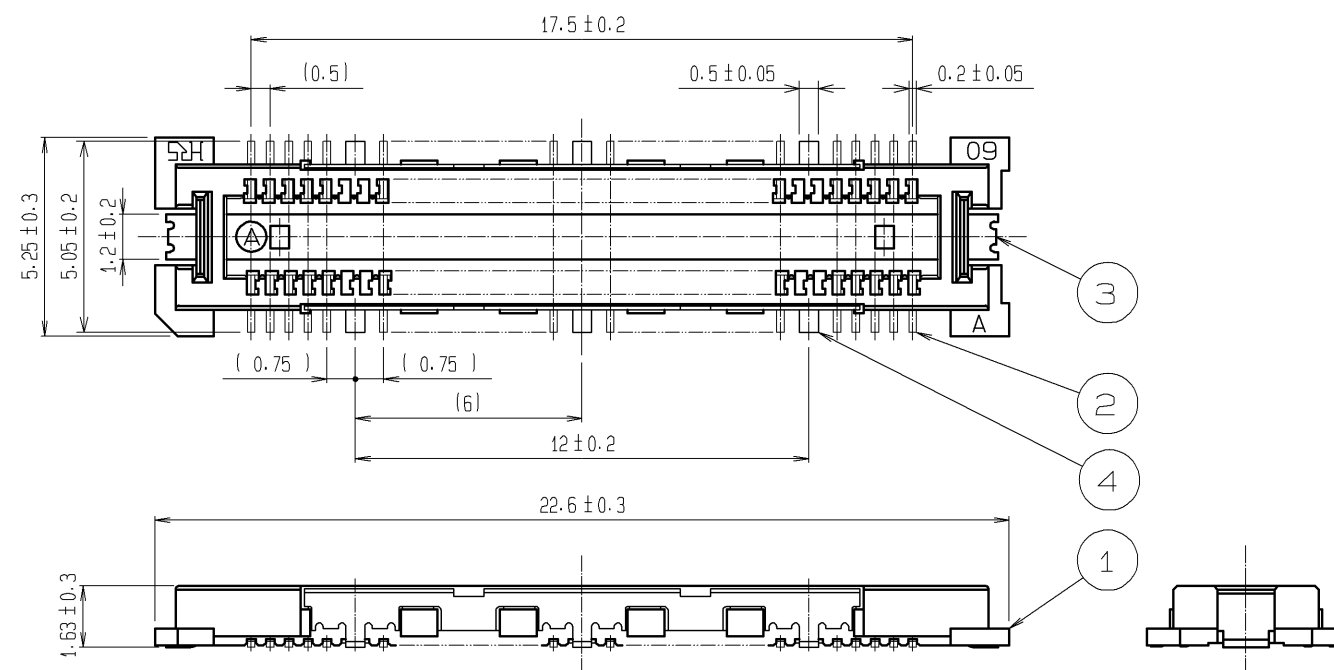
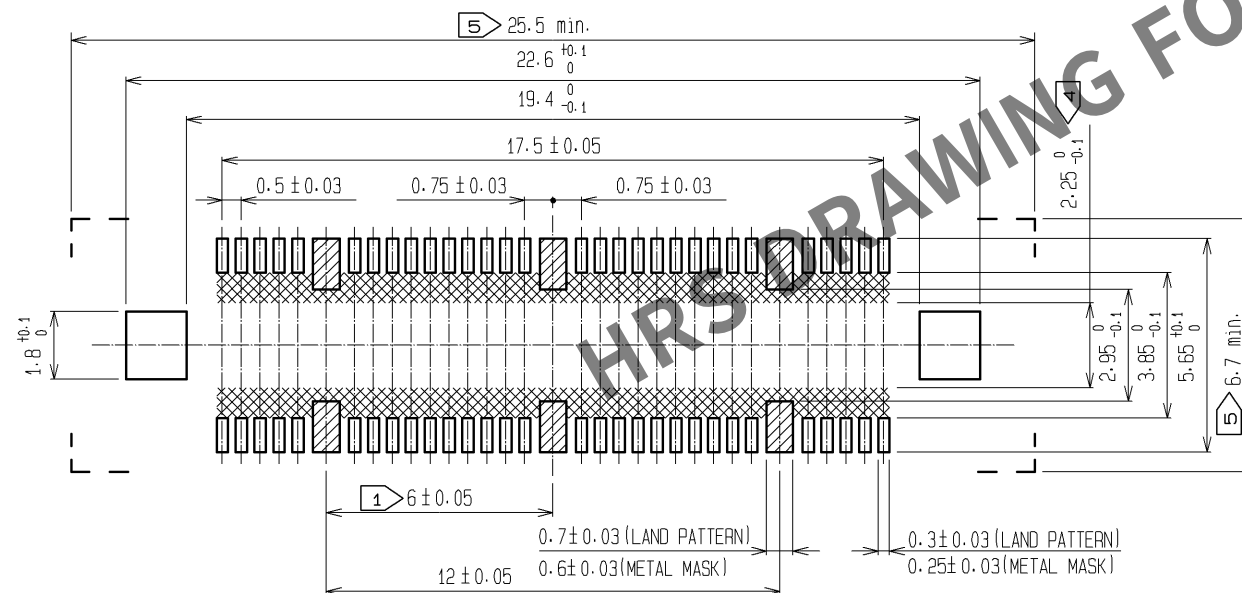
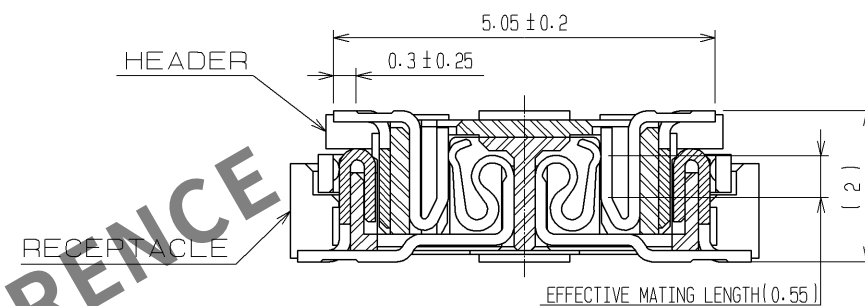




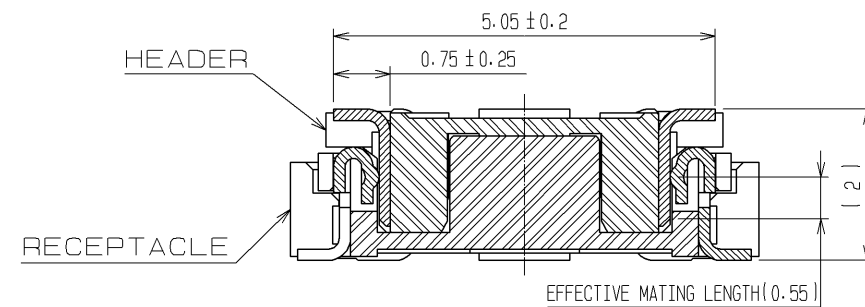
RECOMMENDED LAND PATTERN DIMENSION OF PCB



SIGNAL PORTION CROSS SECTION (10 : 1)



GROUND PORTION CROSS SECTION (10 : 1)



- NOTES
- 6 HATCHED PARTS: GROUND CIRCUIT.
 - SMT LEAD-COPLANARITY: 0.1 MAX.
 - THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - TO BE EMBOSSED CARRIER TAPED AS SPECIFIED IN SHEET 2.
 - THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

			4	PHOSPHOR BRONZE	TIN PLATING	
			3	PHOSPHOR BRONZE	TIN PLATING	
			2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.	
					LEAD AREA : GOLD FLASH	
						UNDER PLATING : NICKEL 1μm min.
1	LCP	BEIGE	UL94V-0			
NO.	MATERIAL	FINISH,	REMARKS	NO.	MATERIAL	FINISH, REMARKS

UNITS mm		SCALE		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
		5 : 1						
HIROSE ELECTRIC CO., LTD.		APPROVED	: HS. OKAWA	07. 07. 13	DRAWING NO.	EDC3-152096-21		
		CHECED	: HS. OZAWA	07. 07. 13	PART NO.	FX11LB-60P/6-SV(91)		
		DESIGNED	: SY. KAMIGA	07. 07. 13	CODE NO.	CL573-0012-0-91		
		DRAWN	: HK. SUNADORI	07. 07. 12				

